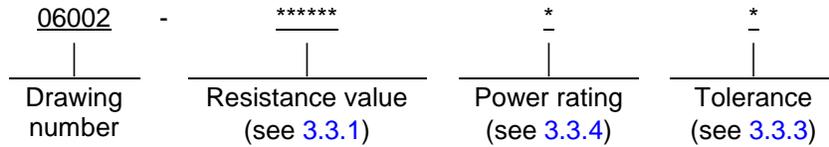




1. SCOPE

1.1 Scope. This drawing describes the requirements for a bulk metal foil, ultra precision, chip resistor, style 2512.

1.2 Part or Identifying Number (PIN). The complete PIN is as follows:



2. APPLICABLE DOCUMENTS

2.1 Government documents.

2.1.1 Specifications and standards. The following specifications, standards and handbooks form a part of this document to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the cited in the solicitation or contract (see 6.2).

DEPARTMENT OF DEFENSE SPECIFICATION

[MIL-PRF-55342](#) - Resistor, Chip, Fixed, Film, Nonestablished Reliability, Established Reliability, Space Level, General Specification for.

DEPARTMENT OF DEFENSE STANDARDS

[MIL-STD-690](#) - Failure Rate Sampling Plans and Procedures.

[MIL-STD-790](#) - Standard Practice for Established Reliability and High Reliability Qualified Products List (QPL) Systems for Electrical, Electronic, and Fiber Optic Parts Specifications.

\* (Copies of these documents are available online at <http://quicksearch.dla.mil/>.)

2.2 Order of precedence. Unless otherwise noted herein or in the contract, in the event of a conflict between the text of this document and the references cited herein (except for related specification sheets), the text of this document takes precedence unless otherwise noted. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be as specified herein.

3.2 Interface and physical dimensions. The interface and physical dimensions shall be as specified in [MIL-PRF-55342](#) and herein (see [figure 1](#)). Passivation is not applicable, however, a protective coating over the element shall be provided.

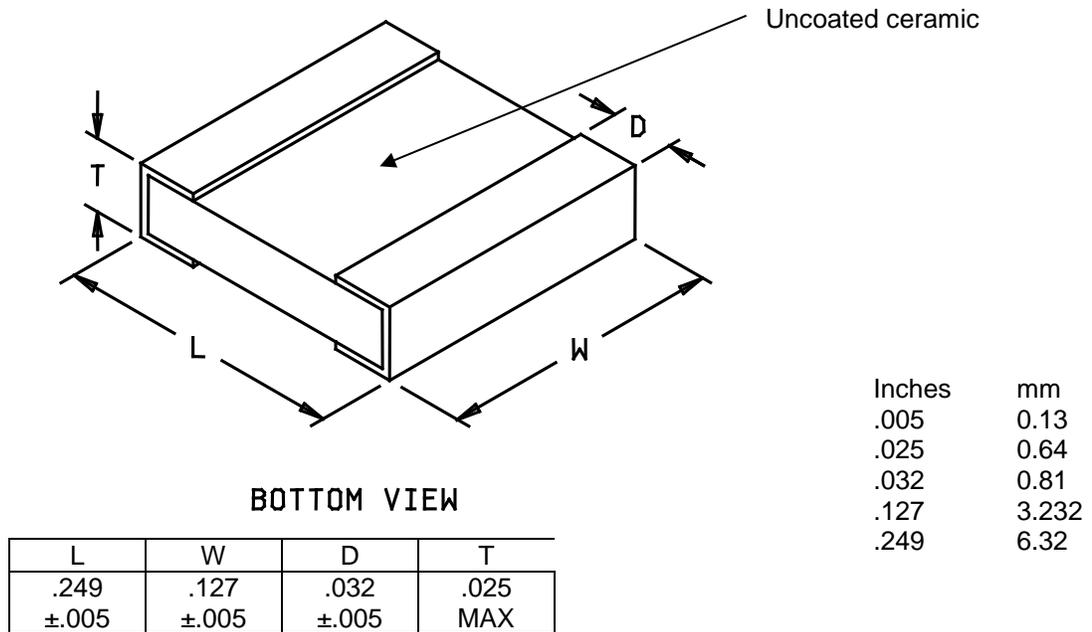
<b>DEFENSE SUPPLY CENTER, COLUMBUS</b> <b>COLUMBUS, OHIO</b>	<b>SIZE</b> <b>A</b>	<b>CODE IDENT NO.</b> <b>037Z3</b>	<b>DWG NO.</b> <b>06002</b>
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3.3 Electrical characteristics

3.3.1 Resistance. The nominal resistance expressed in ohms is identified by six characters, consisting of five digits and a letter. The letter is used simultaneously as a decimal point and as a multiplier. For resistance values:

- a. Greater than or equal to 1 ohm but less than 1,000 ohms, the letter "R" is used to represent a decimal point.
- b. Greater than or equal to 1,000 ohms but less than 1 megohm, the letter "K" is used to represent a decimal point.

All digits preceding and following the letters (R or K) of the group represent significant figures. The resistance value designations are shown in [table I](#). Minimum and maximum resistance values shall be as specified in [3.3.2](#). The standard values for every decade shall follow the sequence specified in the 10 to 100 decade table of [MIL-PRF-55342](#) for resistance tolerances D and F. The resistance values for tolerances T (inactive for new design), Q, A, B, and C may be any value within the limits specified herein, but it is preferred that values be chosen from the "B" column of the 10 to 100 decade table of MIL-PRF-55342. The resistance values for tolerance D shall follow the standard values listed under tolerance B of MIL-PRF-55342.



NOTES:

1. Dimensions are in Inches. Metric equivalents are given for general information only.
2. The pictorial view of the styles above is given as representative of the envelope of the item. Slight deviations from the outline shown, which are contained within the envelope and do not alter the functional aspects of the device, are acceptable.
3. Tolerances shall be +/- 0.005 inch (+/- 0.13 mm) unless otherwise specified.
4. The bottom view shown above represents the mounting side.

FIGURE 1. Chip resistor.

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TABLE I. Designation of resistance values.

Designation	Resistance ohms
10R000 to 99R900 incl.	10 to 99.9 incl.
100R00 to 999R00 incl.	100 to 999 incl.
1K0000 to 9K9900 incl.	1000 to 9,990 incl.
10K000 to 99K900 incl.	10,000 to 99,900 incl.
100K00	100,000

3.3.2 Resistance range and resistance temperature characteristic. The resistance range shall be from 10 ohms to 100 kilohms. The corresponding resistance temperature characteristic is specified in table II.

TABLE II. Resistance range and resistance temperature characteristic.

Resistance range <sup>1/</sup>	Resistance Temperature Characteristic (RTC) in ppm/°C <sup>1/</sup>	Power rating (see 3.3.4)
250 - 150K	± 4	A <sup>1/</sup>
50 - < 250	± 5	
25 - < 50	± 6	
10 - < 25	± 8	
100 - 150K	± 2	B <sup>1/</sup>
50 - < 100	± 3	
10 - < 50	± 4	
250 - 100K	± 4	C
50 - < 250	± 5	
25 - < 50	± 6	
10 - < 25	± 8	
100 - 100K	± 3	D
50 - < 100	± 4	
10 - < 50	± 5	

<sup>1/</sup> Inactive for new design with corresponding resistance range and RTC.

3.3.3 Resistance tolerance. Resistors are available in resistance tolerances as specified in table III.

TABLE III. Resistance tolerance.

Symbol	Resistance tolerance percent	Available resistance range
T <sup>1/</sup>	± 0.01	250 to 150k
Q	± 0.02	
A	± 0.05	100 to 100k
B	± 0.1	50 to 100k
C	± 0.25	25 to 100k
D	± 0.5	10 to 100k
F	± 1.0	

<sup>1/</sup> Inactive for new design

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3.3.4 Power and voltage rating. The power rating is at 70°C derated to +150°C at zero power (see figure 2) and maximum voltage is specified in table IV.

TABLE IV. Power and voltage rating.

Symbol	Maximum power rating (mWatts)	Resistance range in ohms	Voltage (in volts)
A <u>1/</u>	400	10 to 100K, incl	$E = \sqrt{PR}$ E = Voltage P = Power R = Resistance
B <u>1/</u>	750		
C	400		
D	750	10 to 65K, incl.	
	480	65k to 100k, incl.	

1/ Inactive for new design

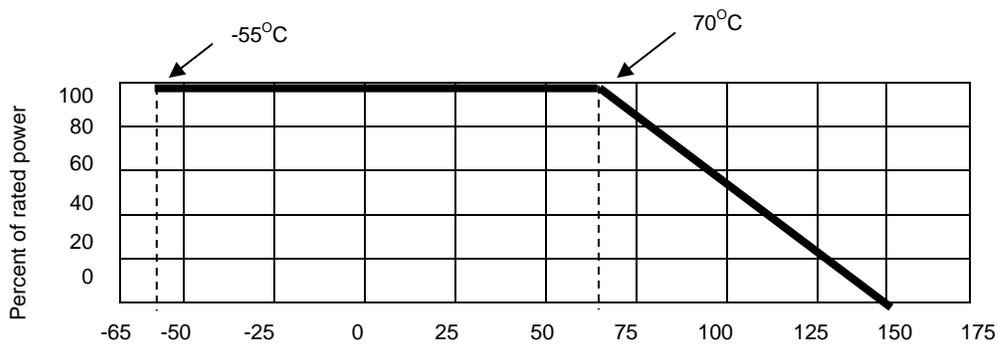


FIGURE 2. Derating curve.

3.3.5 Termination. The termination material shall be in accordance with MIL-PRF-55342, code letter B

3.3.5.1 Pure tin. The use of pure tin, as an underplate or final finish, is prohibited both internally and externally. Tin content of resistor components and solder shall not exceed 97 percent, by mass. Tin shall be alloyed with a minimum of 3 percent lead, by mass (see 6.3).

3.4 Thermal shock. When resistors are tested as specified in MIL-PRF-55342 for thermal shock the change in resistance shall not exceed ±0.03 percent +0.01 ohm.

3.5 Low temperature operation. When resistors are tested as specified in MIL-PRF-55342 for low temperature operation the change in resistance shall not exceed ±0.03 percent +0.01 ohm.

3.6 Short time overload. When resistors are tested as specified in MIL-PRF-55342 for short time overload the change in resistance shall not exceed ±0.02 percent +0.01 ohm.

3.7 High temperature exposure. When resistors are tested as specified in MIL-PRF-55342 for high temperature exposure the change in resistance shall not exceed ±0.03 percent +0.01 ohm.

3.8 Resistance to soldering heat. When resistors are tested as specified in MIL-PRF-55342 for resistance to soldering heat the change in resistance shall not exceed ±0.02 percent +0.01 ohm.

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3.9 Moisture resistance. When resistors are tested as specified in MIL-PRF-55342 for moisture resistance the change in resistance shall not exceed  $\pm 0.1$  percent  $+0.01$  ohm.

3.10 Life. When resistors are tested as specified in MIL-PRF-55342 for life the change in resistance shall not exceed  $\pm 0.05$  percent  $+0.01$  ohm.

3.11 Resistance temperature characteristic. When resistors are tested as specified in MIL-PRF-55342 the RTC shall not exceed the values specified (see 3.3.2).

3.12 Marking. Marking is not required on this resistor; however, each waffle pack and each unit package shall be marked with the PIN assigned herein (see 1.2), the manufacturer's identification code, the date code, and the lot code. At the option of the manufacturer, the resistor may be marked (i.e., laser, color dot, etc.). The marking shall remain legible after all tests.

3.13 Manufacturer eligibility. To be eligible for listing as an approved source of supply, a manufacturer shall be listed on the MIL-PRF-55342 Qualified Product List for at least one part, or perform the group A and group B inspections specified herein on a sample of parts agreed upon by the manufacturer and DLA Land and Maritime-VAT.

3.13.1 Certificate of compliance. A certificate of compliance shall be required from manufacturers requesting to be listed as approved sources of supply.

\* 3.14 Recycled, recovered, environmentally preferable or biobased materials. Recycled, recovered, environmentally preferable or biobased materials should be used to the maximum extent possible provided that the materials meet or exceed the operational and maintenance requirements, and promote economically advantageous life cycle costs.

3.15 Workmanship. Resistors shall be processed in such a manner as to be uniform in quality and be free from defects that will affect life, serviceability, or appearance.

#### 4. VERIFICATION

4.1 Product assurance program. The product assurance program specified in MIL-PRF-55342 and maintained in accordance with MIL-STD-790 is not applicable to this document.

4.2 Qualification inspection. Qualification inspection is not applicable to this document.

4.3 Product level qualification. The product level qualification specified in MIL-PRF-55342 and MIL-STD-690 is not applicable to this document.

4.4 Conformance inspection.

4.4.1 Inspection of product for delivery. Inspection of product for delivery shall consist of group A inspection (ER level only. PPM reporting, subgroup 1, and subgroup 3 are not applicable) and group B inspection of MIL-PRF-55342.

4.4.1.1 Certification. The procuring activity may accept a certificate of compliance in lieu of Group B inspection.

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## 5. PACKAGING

5.1 Packaging. For acquisition purpose, the packaging requirements shall be as specified in the contract or order (see 6.2). When packaging of materiel is to be performed by DoD or in-house contractor personnel, these personnel need to contact the responsible packaging activity to ascertain packaging requirements. Packaging requirements are maintained by the Inventory Control Point's packaging activities within the Military Service or Defense Agency, or within the military services system commands. Packaging data retrieval is available from the managing Military Department's or Defense Agency's automated packaging files, CD-ROM products, or by contacting the responsible packaging activity.

## 6. NOTES

(This section contains information of a general or explanatory nature that may be helpful, but is not mandatory.)

6.1 Intended use. Chip resistors are intended to be used in thick or thin film circuits where microcircuitry is intended, also, for use in surface mounting application.

6.2 Ordering data. The contract or purchase order should specify the following:

- a. Complete PIN (see 1.2).
- b. Requirements for delivery: One copy of the conformance inspection data or a certificate of compliance that parts have passed conformance inspection with each shipment of parts by the manufacturer.
- c. Packaging requirements (see 5.1). (i.e. Electrostatic discharge sensitive packaging).
- d. Whether the manufacturer performs the group B tests or provides certificate of compliance with group B (see 4.4.1.1).

6.3 Tin whisker growth. The use of alloys with tin content greater than 97 percent, by mass, may exhibit tin whisker growth problems after manufacture. Tin whiskers may occur anytime from a day to years after manufacture and can develop under typical operating conditions, on products that use such materials. Conformal coatings applied over top of a whisker-prone surface will not prevent the formation of tin whiskers. Alloys of 3 percent lead, by mass, have shown to inhibit the growth of tin whiskers. For additional information on this matter, refer to [ASTM-B545](#) (Standard Specification for Electrodeposited Coatings of Tin).

6.4 Tolerance caution. Soldering temperature used during installation may cause resistance to shift up to 0.05 %.

6.5 Recommended mounting. A low profile solder fillet is recommended (25 percent to 85 percent of chip "T" dimension). IR, vapor phase, and convection reflow are recommended. The resistance element must be mounted in the up position to prevent failure of the part.

6.6 Electrostatic charge. Under several combinations of conditions, these resistors can be electrically damaged, by electrostatic charges, and drift from specified value. Users should consider this phenomena when ordering or shipping resistors. Direct shipment to Government is controlled by [MIL-DTL-39032](#) that specifies a preventative packaging procedure.

6.7 Pulse applications. Designers are CAUTIONED on using these resistors in pulse applications. Since they have not been qualified nor tested for such applications, damage and premature failure are possible. These resistors only see a one time pulse (Short-time overload) as part of the group B inspection.

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6.8 Users of record. Coordination of this document for future revisions is coordinated only with the approved sources of supply and the users of record of this document. Requests to be added as a recorded user of this drawing may be achieved on-line at [resistor@dla.mil](mailto:resistor@dla.mil) or in writing to: DLA Land and Maritime, ATTN: VAT, P.O. Box 3990, Columbus, OH 43218-3990 or by telephone (614) 692-8754 or DSN 850-8754.

\* 6.9 Approved sources of supply. Approved sources of supply are listed herein. Additional sources will be added as they become available. Assistance in the use of this drawing may be obtained on on-line at [resistor@dla.mil](mailto:resistor@dla.mil) or contact DLA Land and Maritime, ATTN: VAT, P.O. Box 3990, Columbus, OH 43218-3990, or by telephone (614) 692-8754 or DSN 850-8754.

DLA Land and Maritime drawing PIN	Vendor similar designation or type number <u>1/</u>	Vendor CAGE	Vendor name and address
06002-*****A* <u>2/</u> 06002-*****B* <u>2/</u> 06002-*****C* 06002-*****D*	VSM2512*****A* VSMP2512*****B*	0066A	Vishay Precision Group, Inc. 3 Great Valley Parkway Suite 150 Malvern, PA 19355  Plants: Vishay Advanced Technologies, Ltd. 2 Dr. Felix Zandman Street Holon 58125, Israel
06002-*****A* <u>2/</u> 06002-*****B* <u>2/</u> 06002-*****C* 06002-*****D*	TSM2512*****B TSMP2512*****B	2X034	Texas Components Corp. 1716 W. Sam Houston Parkway N. Houston, TX 77043-2723
06002-*****A* <u>2/</u> 06002-*****B* <u>2/</u>	VSM2512*****A* VSMP2512*****B*	OKUU5	Wilbrecht LEDCO, Inc. 155 Waibel Drive, NE, Huron, SD 57350

1/ Parts must be purchased to the DLA Land and Maritime PIN to assure that all performance requirements and test are met.

2/ Inactive for New Design

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